Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	46	("20020050635"\"20020077467"\"20 020109236"\"20020109236"\"20020 135062"\"4313126"\"4402761"\"445 6888"\"4599704"\"4313126"\"44027 61"\"4456888"\"4599704"\"4986861" \"5523628"\"5706578"\"5767009"\"5 825080"\"0050635"\"5156997"\"520 6186"\"5445994"\"5523628"\"58211 38"\"5923087"\"6717244"\"6441478" \"6717244"\"0077467").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/15 15:44
L2	7	("4285780" "5072075" "5274912" "5590461").PN. OR ("5706578"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/12/15 15:44
L3	9	("3489954" "3533023" "4939568" "5311059" "5401687" "5438212" "5721454").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/12/15 15:44
L4	88	("3787252" "4074342" "4500905" "4523211" "4688069" "4761681" "4807021").PN. OR ("4939568"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/12/15 15:44
L5	1	"20040124538".pn.	US-PGPUB; USPAT; USOCR	OR	ON	2005/12/15 15:44
L6	1146	three near2 dimensional near1 (IC integrated adj circuit chip die wafer semiconductor) and "257"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/15 15:44
L7	125	(three near2 dimensional near1 (IC integrated adj circuit chip die wafer semiconductor)).ab. and "257"/\$. ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/15 15:44
L8	3	("5753536" "5902118" "6322903").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/12/15 15:44
L9	3	("5753536" "5902118" "6322903") PN. OR ("6525415"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/12/15 15:44
L10	8	("4461922" "4481378" "5398200" "5401983" "5612552" "5731621" "5747846" "5852310").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/12/15 15:44
L11	2	wiring adj interconnect with copper with transistor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/15 15:44

L12	202	interconnect with copper with transistor	US-PGPUB; USPAT; USOCR; EPO; JPO;	OR	ON	2005/12/15 15:44
L13	144	interconnect near3 copper with	DERWENT; IBM_TDB US-PGPUB;	OR	ON	2005/12/15 15:44
		transistor	USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB			
L14	69	interconnect near3 copper with transistor	USPAT	OR	ON.	2005/12/15 15:44
L15	1	"4939568".pn.	USPAT	OR	ON	2005/12/15 15:44
L16	1	"20040124538".pn.	US-PGPUB; USPAT; USOCR	OR	ON	2005/12/15 15:44
L17	46	("20020050635" "20020077467" "20 020109236" "20020109236" "20020 135062" "4313126" "4402761" "445 6888" "4599704" "4313126" "44027 61" "4456888" "4599704" "4986861" "5523628" "5706578" "5767009" "5 825080" "0050635" "5156997" "520 6186" "5445994" "5523628" "58211 38" "5923087" "6717244" "6441478" "6717244" "0077467") PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/15 15:44
L18	7	("4285780" "5072075" "5274912" "5590461").PN. OR ("5706578"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/12/15 15:44
L19	9	("3489954" "3533023" "4939568" "5311059" "5401687" "5438212" "5721454").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/12/15 15:44
L20	88	("3787252" "4074342" "4500905" "4523211" "4688069" "4761681" "4807021").PN. OR ("4939568"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/12/15 15:44
L21	62	(three near2 dimensional near1 (IC integrated adj circuit chip die wafer semiconductor)).ab. and "438"/\$. ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/15 15:44
L22	1146	three near2 dimensional near1 (IC integrated adj circuit chip die wafer semiconductor) and "257"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/15 15:44
L23	202	interconnect with copper with transistor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/15 15:44

L24							
USPAT; USOCR	L24	62	integrated adj circuit chip die wafer semiconductor)).ab. and "438"/\$.	USPAT; USOCR; EPO; JPO; DERWENT;	OR	ON	2005/12/15 15:44
L27	L25	1	"20040124538".pn.	USPAT;	OR	ON	2005/12/15 15:44
L28	L26	1	"4939568".pn.	USPAT	OR	ON	2005/12/15 15:44
020109226" "20020109236" "20020 USPAT; USOOR B88" "4599704" "4313126" "4402761" "445 G888" "4599704" "4313126" "4402761" "4458688"	L27	1	"20040124538".pn.	USPAT;	OR	ON	2005/12/15 15:44
"5590461"].PN. OR ("5706578"]. USPAT; USOCR	L28	46	020109236" "20020109236" "20020 135062" "4313126" "4402761" "445 6888" "4599704" "4313126" "44027 61" "4456888" "4599704" "4986861" "5523628" "5706578" "5767009" "5 825080" "0050635" "5156997" "520 6186" "5445994" "5523628" "58211 38" "5923087" "6717244" "6441478"	USPAT; USOCR; EPO; JPO; DERWENT;	OR	ON	2005/12/15 15:44
"5311059" "5401667" "5438212" USPAT; USOCR USPAT; USOCR; EPO; JPO; DERWENT; ISM_TDB USPAT USPAT USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB USPAT OR ON 2005/12/15 15:44	L29	7	"5590461").PN. OR ("5706578").	USPAT;	OR	ON	2005/12/15 15:44
"4523211" "4688069" "4761681" USPAT; USOCR	L30	9	"5311059" "5401687" "5438212"	USPAT;	OR	ON	2005/12/15 15:44
L33 3 ("5753536" "5902118" US-PGPUB; U	L31	88	"4523211" "4688069" "4761681" "4807021").PN. OR ("4939568").	USPAT;	OR	ON	2005/12/15 15:44
L34 8 ("4461922" "4481378" "5398200" US-PGPUB; USPAT; USOCR USPAT; USOCR; USOCR;	L32	3		USPAT,	OR	ON	2005/12/15 15:44
L35 2 wiring adj interconnect with copper with USPAT; USOCR USPAT; USOCR USPAT; USOCR USPAT; USOCR USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB USPAT OR ON 2005/12/15 15:44	L33	3	"6322903").PN. OR ("6525415").	USPAT;	OR	ON	2005/12/15 15:44
with transistor USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB L36 69 interconnect near3 copper with USPAT OR ON 2005/12/15 15:44	L34	8	"5401983" "5612552" "5731621"	USPAT;	OR	ON	2005/12/15 15:44
	L35	2	, , ,	USPAT; USOCR; EPO; JPO; DERWENT;	OR	ON	2005/12/15 15:44
	L36	69	• •	USPAT	OR	ON	2005/12/15 15:44

L37	46	("20020050635" "20020077467" "20 020109236" "20020109236" "20020 135062" "4313126" "4402761" "445 6888" "4599704" "4313126" "44027 61" "4456888" "4599704" "4986861" "5523628" "5706578" "5767009" "5 825080" "0050635" "5156997" "520 6186" "5445994" "5523628" "58211 38" "5923087" "6717244" "6441478" "6717244" "0077467").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/15 15:44
L38	7	("4285780" "5072075" "5274912" "5590461").PN. OR ("5706578"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/12/15 15:44
L39	9	("3489954" "3533023" "4939568" "5311059" "5401687" "5438212" "5721454").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/12/15 15:44
L40	88	("3787252" "4074342" "4500905" "4523211" "4688069" "4761681" "4807021").PN. OR ("4939568"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/12/15 15:44
Ĺ41	125	(three near2 dimensional near1 (IC integrated adj circuit chip die wafer semiconductor)).ab. and "257"/\$. ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/15 15:44
L42	144	interconnect near3 copper with transistor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/15 15:44
L43	2	("5940683").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/15 15:44